

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT6286379

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT

**CONVEYING PARTY DATA**

Name	Execution Date
POWERCHIP TECHNOLOGY CORPORATION	09/04/2020

**RECEIVING PARTY DATA**

<b>Name:</b>	NEXCHIP SEMICONDUCTOR CORPORATION
<b>Street Address:</b>	NO. 88, XIFEIHE RD., HEFEI COMPREHENSIVE BONDED ZONE, XINZHAN DISTRICT, HEFEI CITY,
<b>City:</b>	ANHUI PROVINCE
<b>State/Country:</b>	CHINA
<b>Postal Code:</b>	230012

**PROPERTY NUMBERS Total: 24**

Property Type	Number
Patent Number:	6531776
Patent Number:	6444574
Patent Number:	6583055
Patent Number:	6807454
Patent Number:	6670254
Patent Number:	6828633
Patent Number:	7019582
Patent Number:	6699755
Patent Number:	7461472
Patent Number:	7008733
Patent Number:	6881590
Patent Number:	6995086
Patent Number:	7030015
Patent Number:	7056787
Patent Number:	7098124
Patent Number:	7612433
Patent Number:	7803692
Patent Number:	7550372
Patent Number:	7465632
Patent Number:	7429527

PATENT

Property Type	Number
Patent Number:	7268055
Patent Number:	7273787
Patent Number:	8722538
Patent Number:	8822303

**CORRESPONDENCE DATA**

**Fax Number:** (949)391-4699

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**Correspondent Name:** JCIPRNET

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**Address Line 4:** TAIPEI, TAIWAN 100404

<b>ATTORNEY DOCKET NUMBER:</b>	TW2439
<b>NAME OF SUBMITTER:</b>	BELINDA LEE
<b>SIGNATURE:</b>	/Belinda Lee/
<b>DATE SIGNED:</b>	09/07/2020

**Total Attachments: 3**  
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**ASSIGNMENT OF PATENTS AND PATENT APPLICATIONS**

**Powerchip Technology Corporation** a corporation having a place of business at 15F, No. 70, Section 3, Nan-King East Road, Taipei City, Taiwan, R.O.C. (hereafter ASSIGNOR) has been assigned or otherwise has an ownership interest in certain new and useful improvements as set forth in the patents and patent applications listed in attached Appendix A.

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, ASSIGNOR hereby:

- 1) Sell(s), assign(s) and transfer(s) to **Nexchip Semiconductor Corporation**, a corporation having a place of business at No. 88, Xifeihe Rd., Hefei Comprehensive Bonded Zone, Xinzhan District, Hefei City, Anhui Province, PRC 230012 (hereinafter referred to as "ASSIGNEE") the entire right, title and interest in any and all improvements and inventions disclosed in, application(s) based upon, and Patent(s) (including foreign patents) granted upon the information which is disclosed therein.
- 2) Authorize and request the Commissioner of Patents to issue any and all Letters Patents resulting from said application(s) or any division(s), continuation(s), substitute(s), re-examination(s) or reissue(s) thereof to the ASSIGNEE.
- 3) Agree to execute all papers and documents and, entirely at the ASSIGNEE's expense, perform any acts which are reasonably necessary in connection with the prosecution of said application(s), as well as any derivative and applications thereof, foreign applications based thereon, and/or the enforcement of patents resulting from such applications.
- 4) Agree that the terms, covenants and conditions of this assignment shall inure to the benefit of the ASSIGNEE, its successors, assigns and other legal representative(s), and shall be binding upon the inventor(s), as well as the inventor's heirs, legal representatives and assigns.
- 5) Warrant and represent that ASSIGNOR has not entered, and will not enter into any assignment, contract, or understanding that conflicts with this assignment.

Signatures of Assignor and Assignee  
with the execution date of this Assignment indicated beside the signature(s).

Assignor (Conveying Party):

By:   
Typed Name: **CHONG-JEN HUANG**  
Title: **CHAIRMAN**  
Company: **Powerchip Technology Corporation**

Date: 2020 9 4

Assignee (Receiving Party):

By: \_\_\_\_\_  
Typed Name: **Michael Tsai**  
Title: **CHAIRMAN**  
Company: **Nexchip Semiconductor Corporation**

Date: \_\_\_\_\_

ASSIGNMENT OF PATENTS AND PATENT APPLICATIONS

**Powerchip Technology Corporation** a corporation having a place of business at 15F, No. 70, Section 3, Nan-King East Road, Taipei City, Taiwan, R.O.C. (hereafter ASSIGNOR) has been assigned or otherwise has an ownership interest in certain new and useful improvements as set forth in the patents and patent applications listed in attached Appendix A.

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- 3) Agree to execute all papers and documents and, entirely at the ASSIGNEE's expense, perform any acts which are reasonably necessary in connection with the prosecution of said application(s), as well as any derivative and applications thereof, foreign applications based thereon, and/or the enforcement of patents resulting from such applications.
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- 5) Warrant and represent that ASSIGNOR has not entered, and will not enter into any assignment, contract, or understanding that conflicts with this assignment.

Signatures of Assignor and Assignee  
with the execution date of this Assignment indicated beside the signature(s).

Assignor (Conveying Party):

By: \_\_\_\_\_ Date: \_\_\_\_\_  
 Typed Name: **CHONG-JEN HUANG**  
 Title: **CHAIRMAN**  
 Company: **Powerchip Technology Corporation**



Assignee (Receiving Party):

By: Michael Tsai Date: SEP 04 2020  
 Typed Name: **Michael Tsai**  
 Title: **CHAIRMAN**  
 Company: **Nexchip Semiconductor Corporation**

Appendix A

	Patent No.	Attorney Docket No.	client Docket No.
1	6531776	089596-US-PA	PT-AP-0092
2	6444574	089599-US-PA	PT-AP-0095
3	6583055	089600-US-PA	PT-AP-0096
4	6807454	089603-US-PA	PT-AP-0100
5	6670254	008870-US-PA	PT-AP-0104
6	6828633	009919-US-PA	PT-AP-0131
7	7019582	009919-US-PA-1	PT-AP-0131
8	6699755	089615-US-PA	PT-AP-0140
9	7461472	010619-US-PA	PT-AP-0145
10	7008733	089623-US-PA	PT-AP-0178
11	6881590	089625-US-PA	PT-AP-0180
12	6995086	089633-US-PA	PT-AP-0225
13	7030015	089644-US-PA	PT-AP-0260
14	7056787	013042-US-PA	PT-AP-0265
15	7098124	014530-US-PA	PT-AP-0330
16	7612433	015597-US-PA	PT-AP-0337
17	7,803,692	015597-US-PA-1	PT-AP-0337
18	7550372	014985-US-PA	PT-AP-0347
19	7465632	015802-US-PA	PT-AP-0386
20	7,429,527	015945-US-PA-1	PT-AP-0419
21	7268055	016007-US-PA	PT-AP-0420
22	7273787	016077-US-PA	PT-AP-0422
23	8722538	042207-US-PA	PT-AP-1219
24	8822303	041338-US-PA	PT-AP-1251

Nexchip Semiconductor Corp.  
 納奇普半導體股份有限公司  
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